

# MOS FIELD EFFECT TRANSISTOR

# 2SK3356

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

### DESCRIPTION

The 2SK3356 is N-channel MOS Field Effect Transistor designed for high current switching applications.

### **FEATURES**

• Super low on-state resistance:

 $R_{\text{DS(on)1}}$  = 8.0 m $\Omega$  MAX. (Vgs = 10 V, ID = 38 A)

 $R_{\text{DS(on)2}}$  = 12 m $\Omega$  MAX. (VGs = 4 V, ID = 38 A)

- Low Ciss:  $C_{iss} = 6300 \, pF \, TYP$ .
- Built-in gate protection diode

### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

	Drain to Source Voltage	VDSS	60	V
	Gate to Source Voltage	VGSS(AC)	±20	V
	Drain Current (DC)	D(DC)	±75	А
	Drain Current (pulse) Note1	D(pulse)	±300	А
ł	Total Power Dissipation (Tc = 25°C)	P <sub>T1</sub>	135	W
ł	Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T2</sub>	3.0	W
	Channel Temperature	Tch	150	°C
	Storage Temperature	Tstg	-55 to +150	°C
	Single Avalanche Current Note2	las	55	А
	Single Avalanche Energy Note2	Eas	302	mJ

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty cycle  $\leq$  1 %

$$\star$$

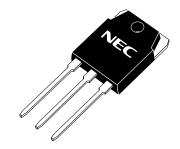
★

**2.** Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = 30 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0 V



PART NUMBER	PACKAGE		
2SK3356	TO-3P		





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Document No. Date Published Printed in Japan

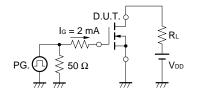
### ELECTRICAL CHARACTERISTICS (TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNI
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 60 V, V_{GS} = 0 V$			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 V$ , $V_{DS} = 0 V$			±10	μA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	$V_{DS} = 10 V, I_{D} = 1 mA$	1.5	2.0	2.5	V
Forward Transfer Admittance	y₁s	Vds = 10 V, Id = 38 A	35	57		S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = 10 V, I_D = 38 A$		6.3	8.0	m۵
	RDS(on)2	Vgs = 4 V, Id = 38 A		8.0	12	m۵
Input Capacitance	Ciss	$V_{DS} = 10 V$ , $V_{GS} = 0 V$ , $f = 1 MHz$		6300		pF
Output Capacitance	Coss			1000		рF
Reverse Transfer Capacitance	Crss			490		pF
Turn-on Delay Time	td(on)	$I_{D} = 38  A,  V_{GS(on)} = 10  V,  V_{DD} = 30  V,$		90		ns
Rise Time	tr	R <sub>G</sub> = 10 Ω		1000		ns
Turn-off Delay Time	td(off)			300		ns
Fall Time	tr			400		ns
Total Gate Charge	QG	ID=75A , $VDD=48V,VGs=10V$		106		nC
Gate to Source Charge	QGS			20		nC
Gate to Drain Charge	Qgd			30		nC
Body Diode Forward Voltage	VF(S-D)	IF = 75 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 75 A, VGS = 0 V,		55		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		100		nC

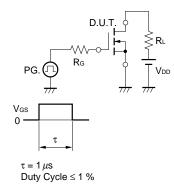
### TEST CIRCUIT 1 AVALANCHE CAPABILITY

# $V_{GS} = 20 \rightarrow 0 \text{ V} \xrightarrow{\text{Ins}} V_{DD}$

### TEST CIRCUIT 3 GATE CHARGE



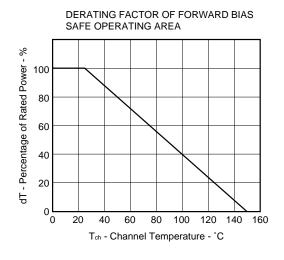
### **TEST CIRCUIT 2 SWITCHING TIME**

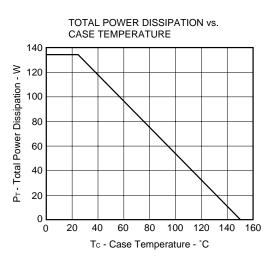


VGS Wave Form	VGS 0 10 % - VGS(on) 90 %
lo Wave Form	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

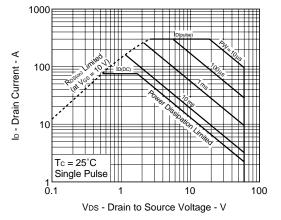
Data Sheet D14133EJ2V0DS

### **★** TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)

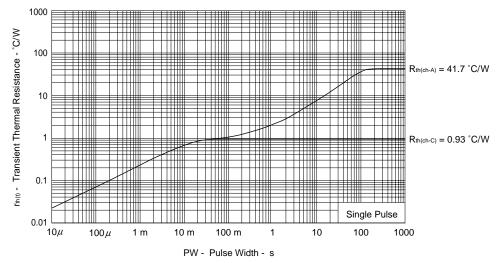




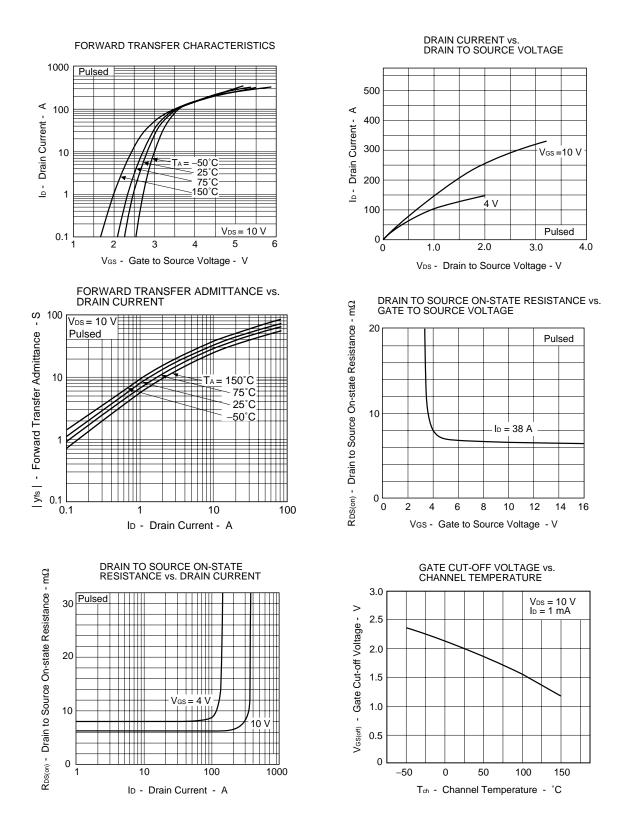
FORWARD BIAS SAFE OPERATING AREA



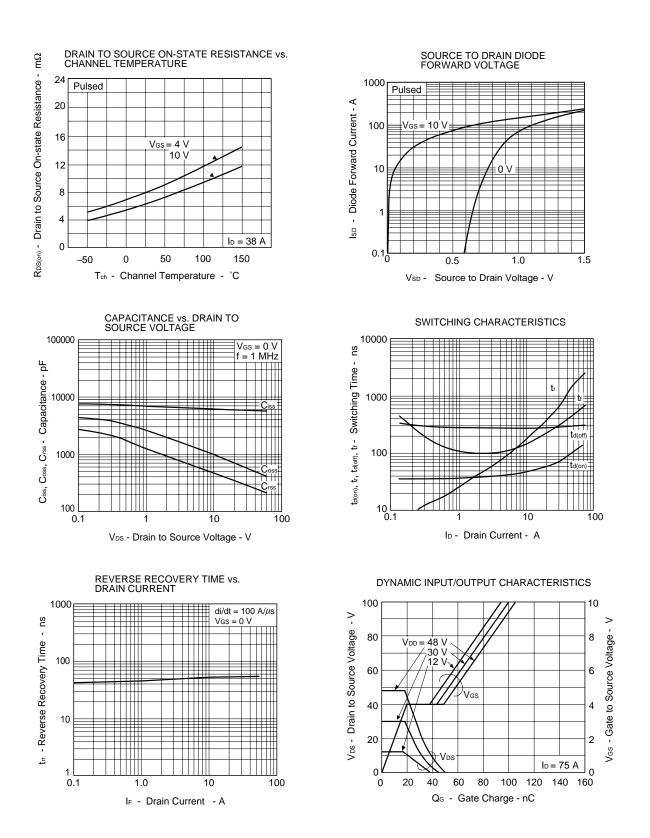
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



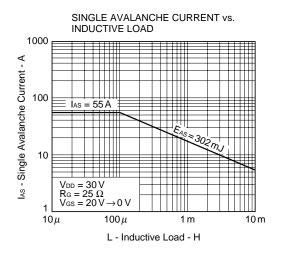
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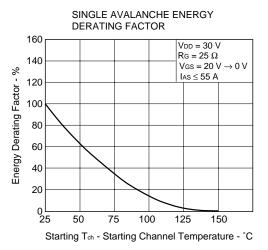


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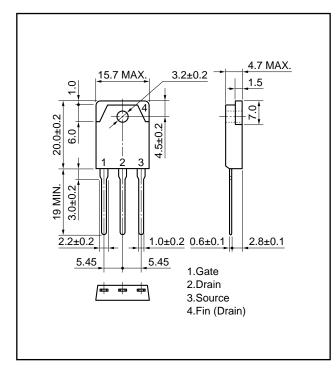
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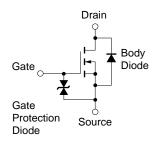


### PACKAGE DRAWING (Unit: mm)

### TO-3P (MP-88)



**EQUIVALENT CIRCUIT** 



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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